



# **HOSTAFORM®**

Hostaform® acetal copolymer grade EC140CF10 is a 10% carbon fiber reinforced grade for increase strength, stiffness and electrical conductivity.

**Preliminary Data Sheet** 

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Resin Identification	POM-CF10	ISO 1043
Part Marking Code	>POM-CF10<	ISO 11469

# Rheological properties

Temperature 190 °C	
Load 2.16 kg	
Moulding shrinkage, parallel 0.8 % ISO 294-	4, 2577
Moulding shrinkage, normal 1.0 % ISO 294-	4, 2577

# Typical mechanical properties

Tensile modulus	8500	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	70	MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	1.5	%	ISO 527-1/-2
Flexural modulus	8500	MPa	ISO 178
Charpy notched impact strength, 23°C	3.2	kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C	3.2	kJ/m²	ISO 179/1eA
Poisson's ratio	0.454		

# Thermal properties

Melting temperature, 10°C/min	165 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	158 °C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	162 °C	ISO 75-1/-2
Coefficient of linear thermal expansion	30 E-6/K	ISO 11359-1/-2
(CLTE), parallel		
Coefficient of linear thermal expansion (CLTE),	100 E-6/K	ISO 11359-1/-2
normal		

# **Electrical properties**

Surface resistivity	1000 Ohm	IEC 62631-3-2
Resistivity, conductive plastics	0.2 Ohm.m	ISO 3915

# Physical/Other properties

D 1	4440 1 / 3	100 4400
Density	1440 kg/m³	ISO 1183

# Injection

Drying Recommended	no
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	3-4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	200 °C
Min. melt temperature	190 °C

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Max. melt temperature	210	°C
Screw tangential speed	≤0.3	m/s
Mold Temperature Optimum	100	°C
Min. mould temperature	80	°C
Max. mould temperature	120	°C
Hold pressure range	60 - 120	MPa
Back pressure	2	MPa

#### Characteristics

Processing Injection Moulding

Delivery form Pellets

Special characteristics Increased electrical conductivity, Static dissipative

#### Additional information

Processing Notes Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

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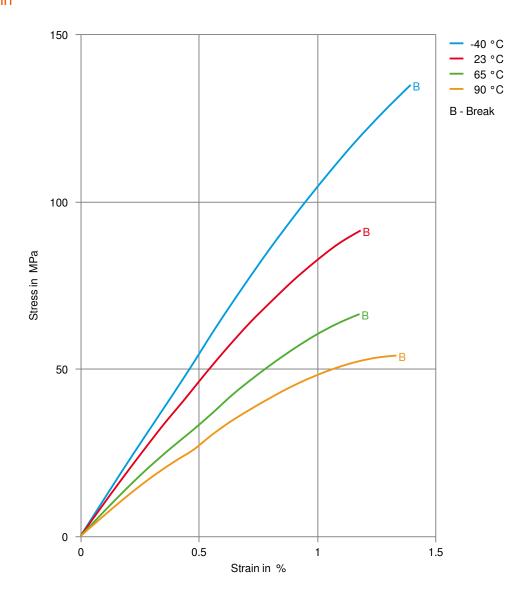
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#### Stress-strain



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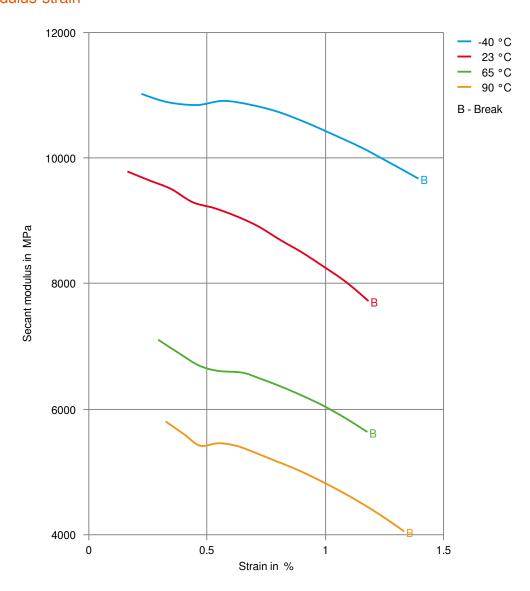
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#### Secant modulus-strain



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